

Vishay Siliconix

N-Channel 55-V (D-S), 175 °C MOSFET, Logic Level

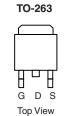
PRODUCT SUMMARY			
$V_{(BR)DSS}(V)$ $r_{DS(on)}(\Omega)$		I <sub>D</sub> (A)	
55	0.019 at V <sub>GS</sub> = 10 V	40	
55	0.025 at V <sub>GS</sub> = 4.5 V	35	

#### FEATURES

- TrenchFET<sup>®</sup> Power MOSFET
- 175 °C Junction Temperature

GC





DRAIN connected to TAB

N-Channel MOSFET

D

Ordering Information: SUM40N05-19L-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS $T_C$	= 25 °C, unless other	wise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	55	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	40		
	T <sub>C</sub> = 100 °C		28		
Pulsed Drain Current		I <sub>DM</sub>	80	A	
Avalanche Current, Single Pulse		I <sub>AS</sub>	30		
Avalanche Energy, Single Pulse L = 0.1 mH		E <sub>AS</sub>	45	mJ	
Power Dissipation	T <sub>C</sub> = 25 °C	Р	65 <sup>a</sup>		
	T <sub>A</sub> = 25 °C <sup>c</sup>	P <sub>D</sub>	3.1 <sup>b</sup>	W	
Operating Junction and Storage Temperature Range	·	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	(PCB Mount) <sup>b</sup>	R <sub>thJA</sub>	40	°C/W
Junction-to-Case		R <sub>thJC</sub>	2.3	0/11

Notes:

a. See SOA curve for voltage derating.

b. Surface Mounted on FR4 board, t  $\leq$  10 s.

\* Pb containing terminations are not RoHS compliant, exemptions may apply.

# SUM40N05-19L

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<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			F				
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 µA	55			v	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{DS} = 250 \ \mu A$	1.0	2.0	3.0		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V$ , $V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 55 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
	I <sub>DSS</sub>	$V_{DS}$ = 55 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			50		
		$V_{DS} = 55 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = 10 V$	40			Α	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0155	0.019		
	<b>F</b>	$V_{GS}$ = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C			0.033	0	
	r <sub>DS(on)</sub>	$V_{GS}$ = 10 V, $I_{D}$ = 20 A, $T_{J}$ = 175 °C			0.040	Ω	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 15 \text{ A}$		0.020	0.025		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A		50		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			885		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$ , $V_{DS} = 25 V$ , f = 1 MHz		185			
Reverse Transfer Capacitance	C <sub>rss</sub>			80			
Total Gate Charge <sup>c</sup>	Qg			10.5	13	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 35 \text{ A}$		4			
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			4.8			
Gate Resistance	R <sub>g</sub>	f = 1.0 MHz		5.0		Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			5	8		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 25 \text{ V}, \text{ R}_{\text{L}} = 0.3 \Omega$ $\text{I}_{\text{D}} \cong 35 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{G}} = 2.5 \Omega$		18	30	- ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			20	30		
Fall Time <sup>c</sup>	t <sub>f</sub>			100	150		
Source-Drain Diode Ratings and Cha	aracteristics T						
Continuous Current	ا <sub>S</sub>				35	٨	
Pulsed Current	I <sub>SM</sub>				80	A	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_F = 35 \text{ A}, V_{GS} = 0 \text{ V}$		1.0	1.5	V	
Reverse Recovery Time	t <sub>rr</sub>			25	40	ns	
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = 35 A, di/dt = 100 A/μs		1.5	2.5	Α	
Reverse Recovery Charge	Q <sub>rr</sub>			0.019	0.05	μC	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

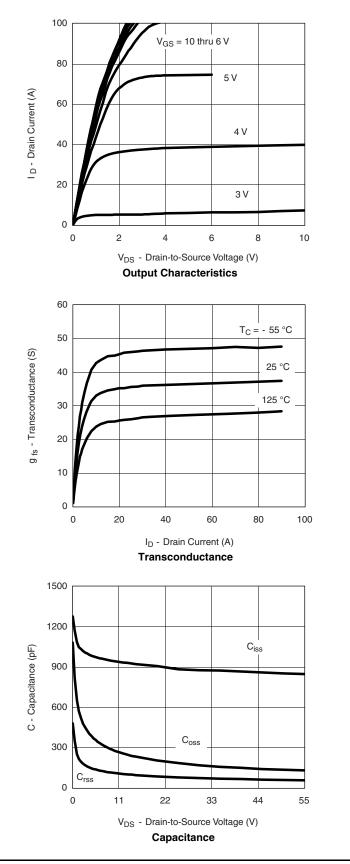
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

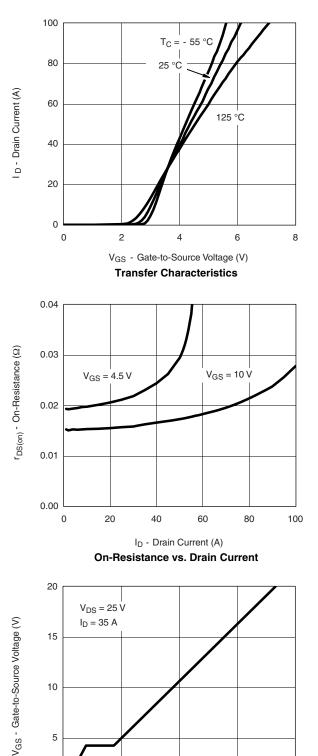


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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





0

0

10

20

Qg - Total Gate Charge (nC)

Gate Charge

40

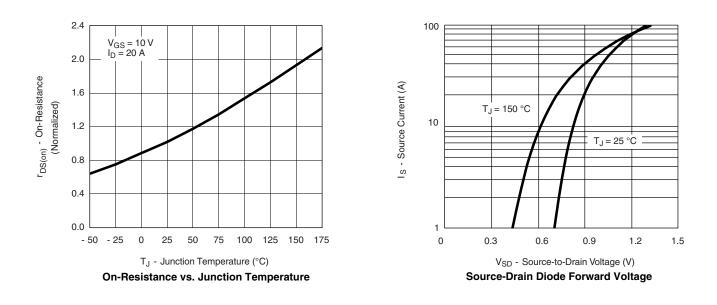
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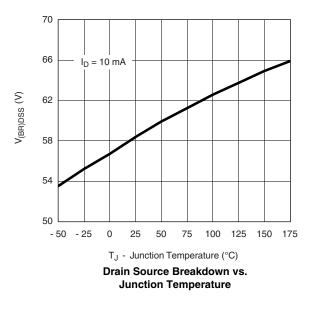
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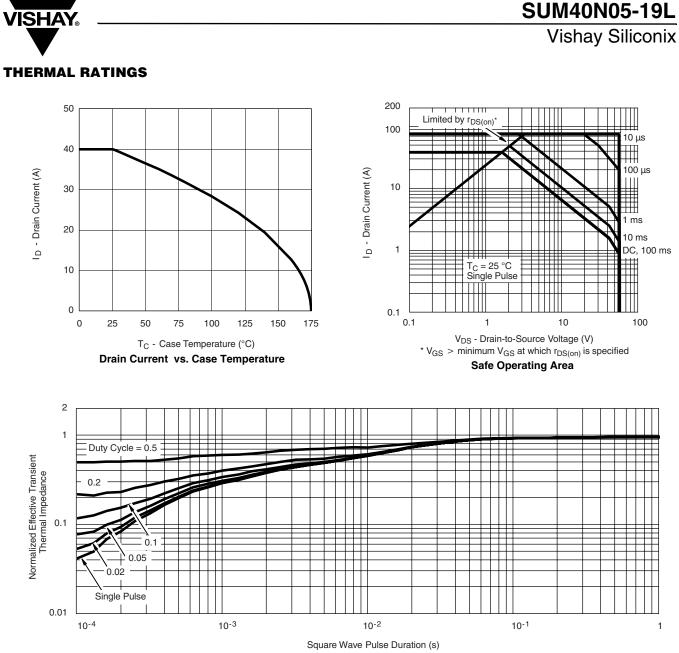


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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72386.



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